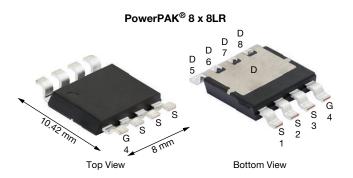
## SQJQ142ER

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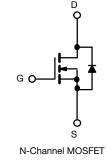
# Automotive N-Channel 40 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY				
V <sub>DS</sub> (V)	40			
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.00124			
I <sub>D</sub> (A) <sup>e</sup>	345			
Configuration	Single			
Package	PowerPAK 8 x 8LR			

#### **FEATURES**

- TrenchFET<sup>®</sup> Gen IV power MOSFET
- AEC-Q101 qualified
- 100 % R<sub>q</sub> and UIS tested
- Thin 1.6 mm package
- · Very low thermal resistance
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



			1)	
<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \text{ °C}$ , unless <b>PARAMETER</b>		SYMBOL		UNIT
Drain-source voltage		V <sub>DS</sub>	40	V
Gate-source voltage		V <sub>GS</sub>	± 20	
Continuous drain current <sup>e</sup>	T <sub>C</sub> = 25 °C	- I <sub>D</sub>	345	
	T <sub>C</sub> = 125 °C		199	
Continuous source current (diode conduction) e		I <sub>S</sub>	252	А
Pulsed drain current <sup>a</sup>		I <sub>DM</sub>	791	
Single pulse avalanche current		I <sub>AS</sub>	48	
Single pulse avalanche energy	L = 0.1 mH	E <sub>AS</sub>	115.2	mJ
Maximum power dissipation <sup>a, e</sup>	T <sub>C</sub> = 25 °C	D	277	W
	T <sub>C</sub> = 125 °C	P <sub>D</sub>	92	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C
Soldering recommendations (peak temperature) d			260	U

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount <sup>c</sup>	R <sub>thJA</sub>	44	°C/W	
Junction-to-case (drain) <sup>d</sup>			0.54	C/ VV	

#### Notes

- a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %
- b. When mounted on 1" square PCB (FR4 material)
- c. See solder profile (www.vishay.com/doc?73257). The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- d. As per JESD51-14
- e. Values based on R<sub>thJC</sub> and T<sub>C</sub> of 25 °C. Actual values achievable will be dependent on the thermal characteristics of the complete system

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static		•			•			
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0, I_D = 250 \ \mu A$		40	-	-	N	
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μΑ	2	3	3.5	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	-	± 100	nA	
Zero gate voltage drain current		$V_{GS} = 0 V$	V <sub>DS</sub> = 40 V	-	-	1		
	I <sub>DSS</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = 40 V, T <sub>J</sub> = 125 °C	-	-	200	μA	
		$V_{GS} = 0 V$	V <sub>DS</sub> = 40 V, T <sub>J</sub> = 175 °C	-	-	330		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{GS} = 10 V$	$V_{DS} \ge 5 V$	100	-	-	А	
Drain-source on-state resistance <sup>a</sup>		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 20 A	-	0.00100	0.00124	Ω	
	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 20 A, T <sub>J</sub> = 125 °C	-	-	0.00200		
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 20 A, T <sub>J</sub> = 175 °C	-	-	0.00240		
Forward transconductance b	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 60 A		-	150	-	S	
Dynamic <sup>b</sup>	•							
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 25 V, f = 1 MHz	-	5360	6975	pF	
Output capacitance	C <sub>oss</sub>			-	2070	2700		
Reverse transfer capacitance	C <sub>rss</sub>			-	167	215		
Total gate charge <sup>c</sup>	Qg	V <sub>GS</sub> = 10 V	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	92	130	nC	
Gate-source charge <sup>c</sup>	Q <sub>gs</sub>			-	26	-		
Gate-drain charge <sup>c</sup>	Q <sub>gd</sub>			-	20.1	-		
Gate resistance	R <sub>g</sub>	f = 1 MHz		0.65	1.59	2.56	Ω	
Turn-on delay time <sup>c</sup>	t <sub>d(on)</sub>			-	18.5	26		
Rise time <sup>c</sup>	tr	$\label{eq:VDD} \begin{array}{l} V_{DD} = 20 \ V, \ R_{L} = 1 \ \Omega \\ I_{D} \cong 20 \ A, \ V_{GEN} = 10 \ V, \ R_{g} = 1 \ \Omega \end{array}$		-	18	25	ns	
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>			-	37	52		
Fall time <sup>c</sup>	t <sub>f</sub>			-	14	20		
Source-Drain Diode Ratings and Cha	aracteristics <sup>b</sup>							
Reverse recovery time	t <sub>rr</sub>			-	59	-	ns	
Reverse recovery charge	Q <sub>rr</sub>			-	69	-	nC	
Reverse recovery current	I <sub>RM</sub>			-	2	3.2	Α	
Pulsed current <sup>a</sup>	I <sub>SM</sub>			-	-	791	А	
Forward voltage	V <sub>SD</sub>	$I_{\rm F} = 50 \text{ A}, V_{\rm GS} = 0$		-	0.8	1.1	V	

#### Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

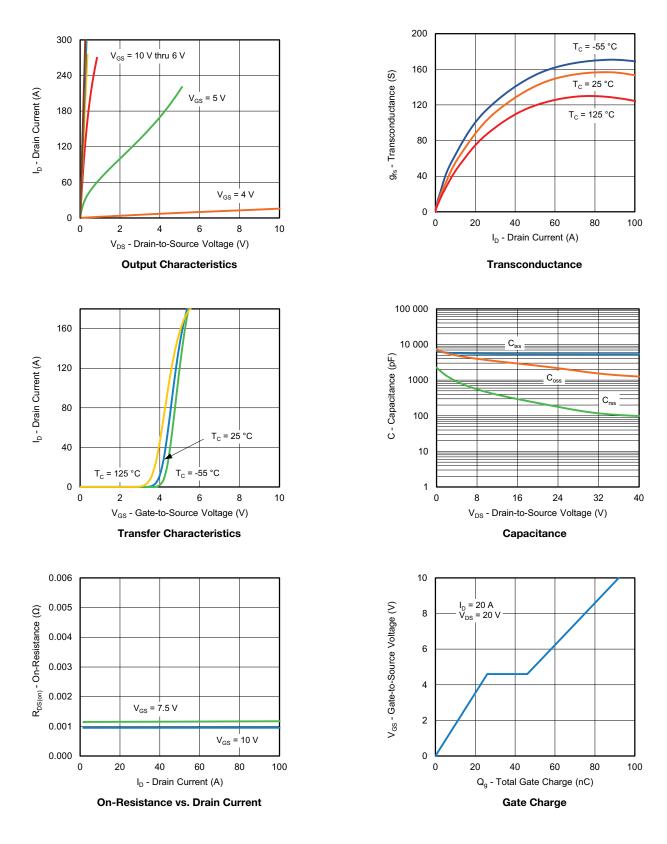
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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#### **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



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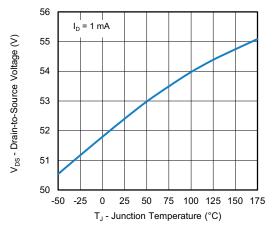
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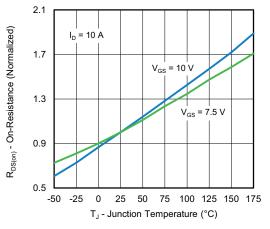
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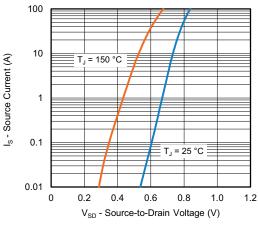
### TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C, unless otherwise noted)



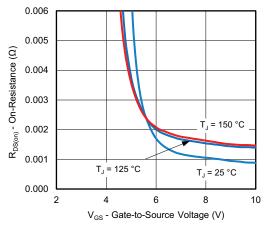
Drain Source Breakdown vs. Junction Temperature



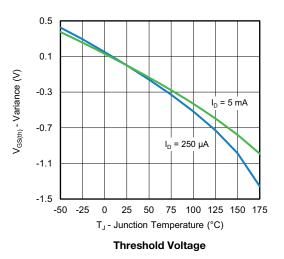
**On-Resistance vs. Junction Temperature** 

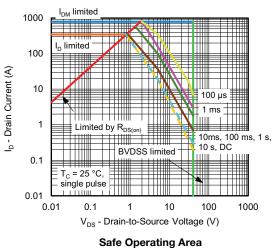


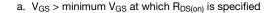
Source Drain Diode Forward Voltage



**On-Resistance vs. Gate-to-Source Voltage** 







S24-0166-Rev. A, 19-Feb-2024

4 For technical questions, contact: automostech

Note

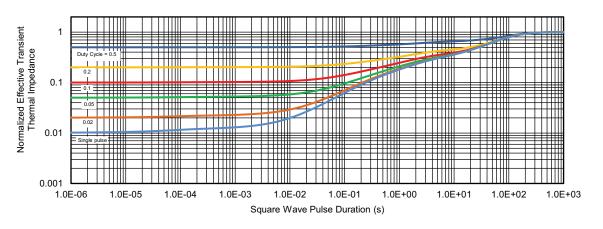
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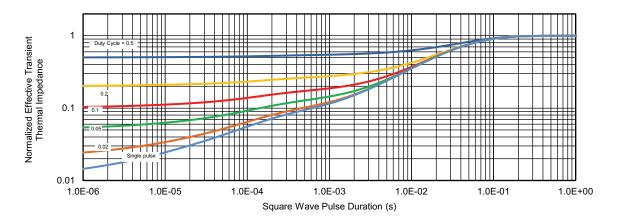


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#### **THERMAL RATINGS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

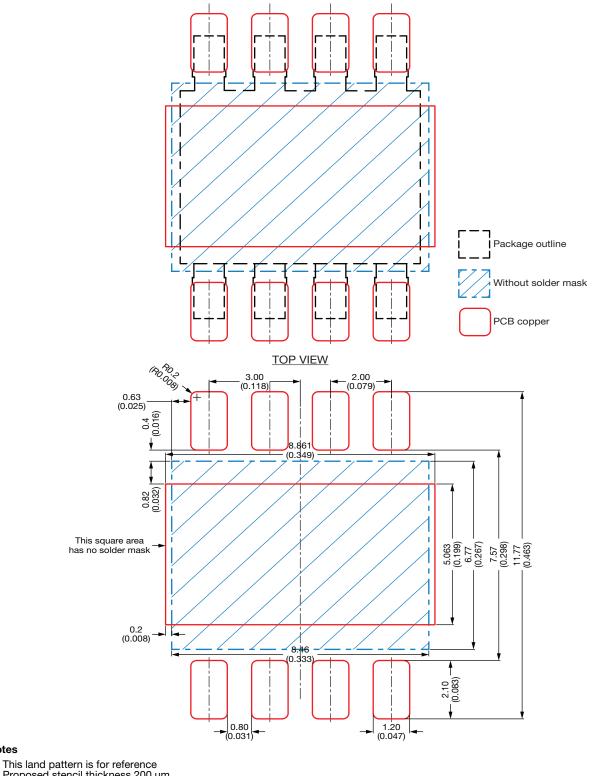
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## **PAD** Pattern



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# **Recommended Land Pattern PowerPAK® 8 x 8LR**



# Proposed stencil thickness 200 µm All dimensions are in millimeter (inches)

ECN: C23-0461-Rev. B, 17-Apr-2023

DWG: 3002

Notes

Revision: 17-Apr-2023

Document Number: 63166

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